DATA SHEET

GTLPH16612

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

Product data 2001 Sep 28

File under Integrated Ciruits ICL03





18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

GTLPH16612

FEATURES

- 18-bit bidirectional bus interface
- Translates between GTLP logic levels (B ports) and LVTTL/TTL logic levels (A ports)
- Edge rate control circuitry on the Bn outputs rising/falling edges to minimize system noise in a multipoint backplane environment
- 5 V I/O tolerant on the LVTTL side
- No bus current loading when LVTTL output is tied to 5 V bus
- 3-State buffers
- Output capability: +64 mA/-32 mA on the LVTTL side; +40 mA on the GTLP side
- LVTTL input levels on control pins
- Power-up reset
- Power-up 3-State
- Positive edge triggered clock inputs
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114,
 200 V MM per JESD22-A115 and 750 V (Bn I/O exceeds 1000 V)
 CDM per JESD22-C101

DESCRIPTION

The GTLPH16612 is a high-performance BiCMOS product designed for V_{CC} operation at 3.3V with I/O compatibility up to 5 V.

The GTLPH16612 is unique in that pin 50 is a no connect and this device can be used as a replacement device in sockets where pin 50 is 3.3/5 V V_{CC} or 3.3 V BIAS V_{CC} .

This device is an 18-bit universal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OEAB and OEBA), latch enable (LEAB and LEBA), and clock (CPAB and CPBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is High. When LEAB is Low, the A data is latched if CPAB is held at a High or Low logic level. If LEAB is Low, the A-bus data is stored in the latch/flip-flop on the Low-to-High transition of CPAB. When OEAB is Low, the outputs are active. When OEAB is High, the outputs are in the high-impedance state. The clocks can be controlled with the clock-enable inputs (CEBA/CEAB).

Data flow for B-to-A is similar to that of A-to-B but uses $\overline{\text{OEBA}}$, LEBA and CPBA.

QUICK REFERENCE DATA

| CVMPOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|--------------------------------------|---|------------------------------------|---------|------|
| SYMBOL | PARAMETER | T _{amb} = 25 °C | 3.3 V | UNII |
| t _{PLH} t _{PHL} | Propagation delay An to Bn or Bn to An | C _L = 50 pF | 1.9 | ns |
| C _{IN} | Input capacitance (Control pins) | $V_I = 0 \text{ V or } V_{CC}$ | 4 | pF |
| C _{I/O} | An I/O pin capacitance | $V_{I/O} = 0 \text{ V or } V_{CC}$ | 9 | pF |
| C _{I/O} | Bn I/O pin capacitance | V _{I/O} = 0 V or 1.5 V | 5.3 | pF |
| I _{CCZ} | Total supply current | Outputs disabled | 12 | mA |

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | ORDER CODE | DWG NUMBER | |
|----------------------|-------------------|---------------|------------|--|
| 56-Pin Plastic SSOP | −40 to +85 °C | GTLPH16612DL | SOT371-1 | |
| 56-Pin Plastic TSSOP | –40 to +85 °C | GTLPH16612DGG | SOT364-1 | |

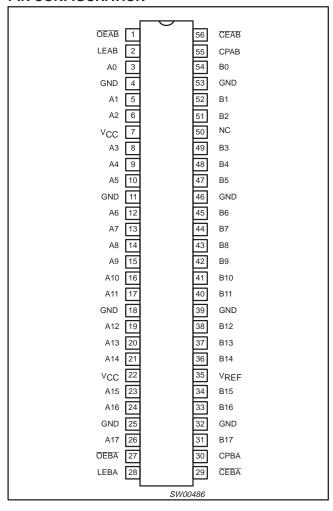
NOTE:

^{1.} Standard packing quantities and other packaging data is available at www.philipslogic.com/support/packages.

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

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PIN CONFIGURATION



PIN DESCRIPTION

| PIN NUMBER | SYMBOL | NAME AND FUNCTION |
|--|-----------------|--|
| 1, 27 | OEAB/OEBA | A-to-B/ B-to-A Output enable input (active Low) |
| 29, 56 | CEBA/CEAB | B-to-A/A-to-B clock enable |
| 2, 28 | LEAB/LEBA | A-to-B/B-to-A Latch enable input |
| 55, 30 | CPAB/CPBA | A-to-B/B-to-A Clock input (active rising edge) |
| 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26 | A0-A17 | Data inputs/outputs (A side) |
| 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31 | B0-B17 | Data inputs/outputs (B side) |
| 4, 11, 18, 25, 32, 39, 46, 53 | GND | Ground (0V) |
| 7, 22 | V _{CC} | Positive supply voltage |
| 35 | V_{REF} | GTLP reference voltage |
| 50 | NC | No connect |

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FUNCTION TABLE

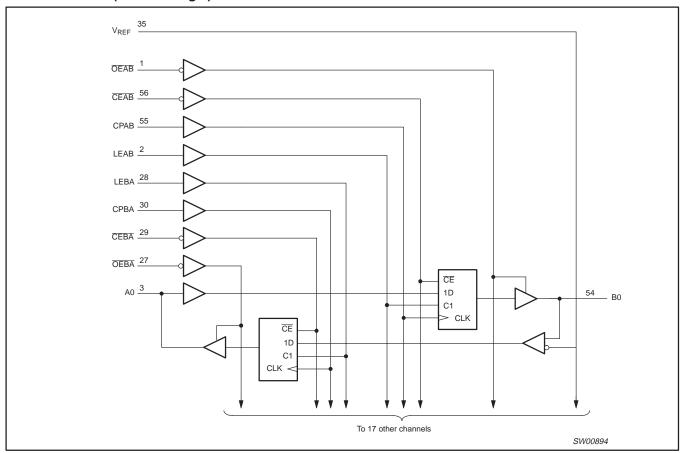
| | II | NPUTS | | | OUTPUT | |
|------|------|-------|------|---|-----------------------------|----------------------------|
| CEAB | OEAB | LEAB | CPAB | Α | В | MODE |
| Х | Н | Х | Х | Х | Z | Isolation |
| L | L | L | 1 | L | L | Clocked storage of A data |
| L | L | L | 1 | Н | Н | Clocked storage of A data |
| Х | L | Н | Х | L | L | Transparent |
| Х | L | Н | Х | Н | Н | Hansparent |
| L | L | L | Н | Х | B _O [±] | Latched storage of A data |
| L | L | L | L | Х | B _O § | Latorieu storage of A data |
| Н | L | L | Х | Х | B_O^\pm | Clock inhibit |

- X = Don't care
- H = High voltage level
- L = Low voltage level

 ↑ = Low to High
- Z = High impedance "off" state
- † = A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{\text{OEBA}}$, LEBA, CPBA, and $\overline{\text{CEBA}}$. The condition when $\overline{\text{OEAB}}$ and $\overline{\text{OEBA}}$ are both low at the same time is not recommended.
- ± = Output level before the indicated steady-state input conditions were established.

 § = Output level before the indicated steady-state input conditions were established, provided that CPAB was Low before LEAB went Low.

LOGIC SYMBOL (Positive Logic)



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ABSOLUTE MAXIMUM RATINGS1, 2

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|------------------|---|-------------------------------------|--------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +4.6 | V |
| I _{IK} | DC input diode current | V _I < 0 V | -50 | mA |
| W | DC input voltage ³ | A port | -0.5 to +7.0 | l v |
| VI | DC input voltages | B port | -0.5 to +4.6 | V |
| lok | DC output diode current | V _O < 0 V; A port | -50 | mA |
| W | DC output voltage ³ | Output in Off or High state; A port | -0.5 to +7.0 | V |
| V _{OUT} | DC output voltages | Output in Off or High state; B port | -0.5 to +4.6 | V |
| | Current into any output in the LOW state | A port | 128 | mA |
| loL | Current into any output in the LOW state | B port | 80 | mA |
| I _{OH} | Current into any output in the HIGH state | A port | -64 | mA |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
- 3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS^{1, 2}

| 0)/4501 | DADAMETED | TEST CONDITIONS | 3.3 | 3.3V RANGE LIMITS | | | |
|---------------------|--------------------------------------|-----------------|------------------------|-------------------|------------------------|------|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
| V _{CC} | DC supply voltage | | 3.0 | 3.3 | 3.6 | V | |
| \ <u>'</u> | Tormination valtage | GTL | 1.14 | 1.2 | 1.26 | V | |
| V_{TT} | Termination voltage | GTLP | 1.35 | 1.5 | 1.65 | l v | |
| V | GTL reference voltage | GTL | 0.74 | 0.8 | 0.87 | V | |
| V_{REF} | GTE reference voltage | GTLP | 0.9 | 1 | 1.10 | 1 ° | |
| | lanut voltage | B port | 0 | V _{TT} | Note 3 | V | |
| V_{I} | put voltage | Except B port | 0 | V _{CC} | 5.5 | V | |
| ., | HIGH-level input voltage | B port | V _{REF} +50mV | _ | <u> </u> | V | |
| V_{IH} | | Except B port | 2.0 | _ | _ | | |
| | LOW level input valtage | B port | _ | _ | V _{REF} -50mV | V | |
| V_{IL} | LOW-level input voltage | Except A port | _ | _ | 0.8 | l v | |
| I _{OH} | HIGH-level output current | A port | _ | _ | -32 | mA | |
| | | B port, GTL | _ | _ | 32 | mA | |
| I_{OL} | LOW-level output current | B port, GTLP | _ | _ | 40 | mA | |
| | | A port | _ | _ | 64 | mA | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | _ | | 10 | ns/V | |
| Δt/ΔV _{CC} | Power-up rate | | 20 | | _ | μs/V | |
| T _{amb} | Operating free-air temperature range | | -40 | _ | +85 | °C | |

- 1. Normal connection sequence is GND first; V_{CC} , I/O, control inputs, V_{TT} and V_{REF} (any order) last.
- V_{REF} can be adjusted to optimize noise margins, but normally is two-thirds V_{TT}.
 V_{TT} and R_{TT} can be adjusted to accommodate backplane impedances if the DC recommended I_{OL} ratings are not exceeded and the absolute max V_I rating is not exceeded.

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DC ELECTRICAL CHARACTERISTICS (3.3 V \pm 0.3 V RANGE)

| | //BOL PARAMETER | | | | | LIMITS | | |
|-------------------------------|--|-------------------------|--|---|----------------------|-----------------|------------------|----------------|
| SYMBOL | | | TEST CONDIT | TIONS | Temp = | -40 to + | 85 °C | UNIT |
| | | | | MIN | TYP ¹ | MAX | | |
| V _{IK} | Input clamp vo | ltage | $V_{CC} = 3.0 \text{ V}; I_{IK} = -18 \text{ mA}$ | | _ | -0.85 | -1.2 | V |
| | LP ab last at a set | | $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}; I_{OH} = -100 \mu\text{A}$ | Anna | V _{CC} -0.2 | V _{CC} | _ | ., |
| V_{OH} | High-level outp | out voitage | $V_{CC} = 3.0 \text{ V}; I_{OH} = -32 \text{ mA}$ | A port | 2.0 | 2.3 | _ | ٧ |
| | | | $V_{CC} = 3.0 \text{ V}; I_{OL} = 100 \mu\text{A}$ | | - | 0.07 | 0.2 | |
| | | | V _{CC} = 3.0 V; I _{OL} = 16 mA |) A | _ | 0.25 | 0.4 | V |
| V_{OL} | Low-level outp | ut voltage | V _{CC} = 3.0 V; I _{OL} = 32 mA | A port | _ | 0.3 | 0.5 | 1 ^v |
| | | | V _{CC} = 3.0 V; I _{OL} = 64 mA | 1 | _ | 0.4 | 0.55 | 1 |
| | | | V _{CC} = 3.0 V; I _{OL} = 40 mA | B port | - | 0.4 | 0.5 | V |
| | | | $V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}$ | O antoni n'an | - | 0.1 | ±1 | |
| | | | V _{CC} = 0 or 3.6 V; V _I = 5.5 V | Control pins | _ | 0.1 | 10 | μΑ |
| | <u> </u> | | V _{CC} = 3.6 V; V _I = 5.5 V | | <u> </u> | 0.1 | 20 | μА |
| l _l | Input leakage of | current | V _{CC} = 3.6 V; V _I = V _{CC} | I/O Data pins ⁴ A port | _ | 0.5 | 10 | |
| | | | V _{CC} = 3.6 V; V _I = 0 V | 1 | _ | 0.1 | -5 | |
| | | | $V_{CC} = 3.6 \text{ V}; V_I = V_{TT} \text{ or GND}$ | B port | <u> </u> | _ | ±5 | μΑ |
| I _{OFF} | Output off curre | ent | $V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5 \text{ V}$ | | - | 0.1 | ±100 | μΑ |
| | 5 | | V _{CC} = 3 V; V _I = 0.8 V | | 75 | 130 | _ | , |
| I _{HOLD} | Bus Hold curre | ent, A outputs | V _{CC} = 3 V; V _I = 2.0 V | | -75 | -140 | _ | μΑ |
| I _{EX} | Current into an High state whe | | V _O = 5.5 V; V _{CC} = 3.0 V | A port | _ | 10 | 125 | μΑ |
| I _{PU/PD} | Power up/dowi | | $V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC}; V_I$ $\overline{OE} = \text{Don't care}$ | = GND or V _{CC} | _ | 1.0 | ±100 | μА |
| I _{CCH} | A David | | Outputs high | | - | 5.0 | 9.0 | |
| I _{CCL} | A-Port | | Outputs low | 1 | _ | 10.5 | 18.5 | 1 |
| I _{CCZ} ⁵ | | V _{CC} = 3.6 V | Disabled | $V_I = GND \text{ or } V_{CC};$ $I_{CC} = 0$ | _ | 6.0 | 11.5 | mA |
| I _{CCH} | | | Outputs high |] | _ | 9.7 | 17.5 | 1 |
| I _{CCL} | B-Port | | Outputs low | 1 | _ | 7.0 | 12.0 | 1 |
| Δl _{CC} | Additional supplinput pin ² | oly current per | V _{CC} = 3 V to 3.6 V; One input at V _{CC} –0.6 V, Other inputs at V _{CC} or GND | | _ | 0.04 | 0.2 | mA |
| C _{IN} | Control pins ca | pacitance | V _I = 0 V or V _{CC} | | _ | 4 | _ | pF |
| C _{I/O} | An I/O pin capa | acitance | $V_{I/O} = 0 \text{ V or } V_{CC}$ | | - | 9.0 | _ | pF |
| C _{I/O} | Bn I/O pin capa | acitance | V _{I/O} = 0 V or 1.5 V | | T - | 5.3 | 7.3 ⁶ | pF |

- All typical values are at V_{CC} = 3.3 V and T_{amb} = 25 °C.
 This is the increase in supply current for each LVTTL input at the specified voltage level other than V_{CC} or GND
 This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 msec. From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 μ sec is permitted. This parameter is valid for $T_{amb} = 25$ °C only.
- 4. Unused pins at V_{CC} or GND.
- 5. I_{CCZ} is measured with outputs pulled up to V_{CC} or pulled down to ground. 6. The maximum Bn I/O pin capacitance is based on simulation data.

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AC CHARACTERISTICS (A PORT)

GND = 0 V; t_r = t_f = 2.5 ns; C_L = 50 pF; R_L = 500 Ω ; T_{amb} = -40 to +85 °C.

| | | | | GTLP | | | | |
|------------------|--------------------|----------|-----|--------------------------|--------------------------------|------|--|--|
| | GTLPH16612 An Port | | | | V _{CC} = 3.3 V ±0.3 V | | | |
| | | | , | V _{REF} = 1.0 \ | / | UNIT | | |
| SYMBOL | PARAMETER | WAVEFORM | MIN | TYP ¹ | MAX | 1 | | |
| F _{max} | | | 250 | 290 | _ | MHz | | |
| t _{PLH} | Bn to An | 2 | 1.5 | 2.6 | 5.5 | ns | | |
| t _{PHL} | Bn to An | 2 | 2.6 | 4.3 | 6.5 | ns | | |
| t _{PLH} | LEBA to An | 3 | 1.6 | 3.0 | 4.9 | ns | | |
| t _{PHL} | LEBA to An | 3 | 2.0 | 3.0 | 4.5 | ns | | |
| t _{PLH} | CPBA to An | 1 | 1.1 | 2.7 | 4.9 | ns | | |
| t _{PHL} | CPBA to An | 1 | 1.8 | 3.0 | 4.6 | ns | | |
| t _{PZH} | OEBA to An | 5 | 1.5 | 4.3 | 6.2 | ns | | |
| t _{PHZ} | OEBA to An | 5 | 1.4 | 3.6 | 4.8 | ns | | |
| t _{PZL} | OEBA to An | 6 | 1.5 | 3.8 | 6.2 | ns | | |
| t _{PLZ} | OEBA to An | 6 | 1.0 | 2.6 | 5.5 | ns | | |

NOTE:

AC CHARACTERISTICS (B PORT)

GND = 0 V; $t_r = t_f$ = 2.5 ns; C_L = 30 pF; R_L = 25 Ω ; T_{amb} = -40 to +85 °C.

| | | | | GTLP | | |
|-------------------|---------------------------|-------------------|--|--------------------------|------|-------|
| | G [.] | TLPH16612 Bn Port | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | UNIT | |
| | | | | V _{REF} = 1.0 \ | / | JUNII |
| SYMBOL | PARAMETER | WAVEFORM | MIN | TYP ¹ | MAX | 1 |
| F _{max} | | | 250 | 270 | _ | MHz |
| t _{PLH} | An to Bn | 2 | 1.8 | 4.8 | 9.0 | ns |
| t _{PHL} | An to Bn | 2 | 1.0 | 3.9 | 8.2 | ns |
| t _{PLH} | LEAB to Bn | 3 | 1.9 | 4.6 | 8.4 | ns |
| t _{PHL} | LEAB to Bn | 3 | 1.9 | 4.5 | 8.0 | ns |
| t _{PLH} | CPAB to Bn | 1 | 2.7 | 5.1 | 8.7 | ns |
| t _{PHL} | CPAB to Bn | 1 | 2.2 | 4.9 | 8.6 | ns |
| t _{PLH} | OEAB to Bn | 7 | 1.4 | 4.2 | 8.3 | ns |
| t _{PHL} | OEAB to Bn | 7 | 1.5 | 5.0 | 9.5 | ns |
| t _{rise} | Transition time B outputs | 20% to 80% | _ | 3.1 | _ | ns |
| t _{fall} | Transition time B outputs | 20% to 80% | _ | 4.6 | _ | ns |

NOTE:

^{1.} Typical values are at V_{CC} = 3.3 V, T_{amb} = +25 °C.

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AC SETUP REQUIREMENTS (3.3 V \pm 0.3 V RANGE)

A Port: GND = 0 V; Input $t_r = t_f = 2.5$ ns; $C_L = 50$ pF; $R_L = 500$ Ω ; $T_{amb} = -40$ to +85 °C; $V_{REF} = 0.8$ V or 1.0 V. B Port: GND = 0 V; Input $t_r = t_f = 2.5$ ns; $C_L = 30$ pF; $R_L = 25$ Ω ; $V_{REF} = 0.8$ V or 1.0 V.

| | | PARAMETER | | | | | |
|-------------------------|----------------|------------------------------|----------|--------------------------------|-----|-----|------|
| SYMBOL | DESCRIPTION | | WAVEFORM | V _{CC} = 3.3 V ±0.3 V | | | UNIT |
| | | | | MIN | TYP | MAX | 1 |
| t _w (H) | Pulse duration | LEAB or LEBA | 3 | 1.0 | _ | _ | ns |
| t _w (H or L) | Pulse duration | CPAB or CPBA | 4 | 2.5 | _ | _ | ns |
| t _s (H or L) | Setup time | An before CPAB rising edge | 4 | 2.0 | _ | _ | ns |
| t _s (H) | Setup time | Bn before CPBA rising edge | 4 | 2.5 | _ | _ | ns |
| t _s (L) | Setup time | Bn before CPBA rising edge | 4 | 3.1 | _ | _ | ns |
| t _s (H or L) | Setup time | An before LEAB falling edge | 4 | 0.5 | _ | _ | ns |
| t _s (H or L) | Setup time | Bn before LEBA falling edge | 4 | 2.5 | _ | _ | ns |
| t _s (L) | Setup time | CEAB before CPAB rising edge | 4 | 0 | _ | _ | ns |
| t _s (L) | Setup time | CEBA before CPBA rising edge | 4 | 0 | _ | _ | ns |
| t _h (H or L) | Hold time | An after CPAB rising edge | 4 | 0 | _ | _ | ns |
| t _h (H or L) | Hold time | Bn after CPBA rising edge | 4 | 0 | _ | | ns |
| t _h (H or L) | Hold time | An after LEAB falling edge | 4 | 0.5 | _ | _ | ns |
| t _h (H or L) | Hold time | Bn after LEBA falling edge | 4 | 0 | _ | _ | ns |
| t _h (H) | Hold time | CEAB after CPAB rising edge | 4 | 1.1 | _ | | ns |
| t _h (H) | Hold time | CEBA after CPBA rising edge | 4 | 1.1 | _ | _ | ns |

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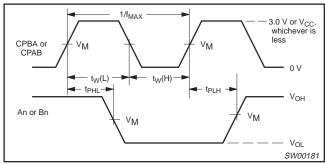
GTLPH16612

AC WAVEFORMS

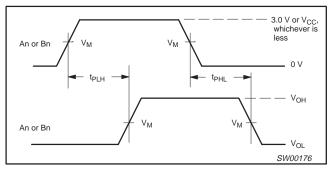
 V_M = 1.5 V at $V_{CC} \ge 3.0$ V. V_M = 1.5 V for A ports and control pins; V_M = 1.0 V for B ports in GTLP mode.

 V_X = V_{OL} + 0.3 V at $V_{CC}\,\geq\,3.0$ V.

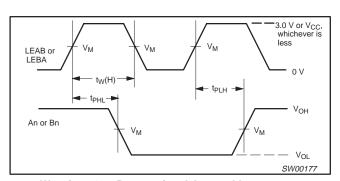
 $V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \ge 3.0 \text{ V}.$



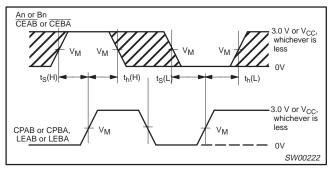
Waveform 1. Propagation delay, clock input to output, clock pulse width, and maximum clock frequency



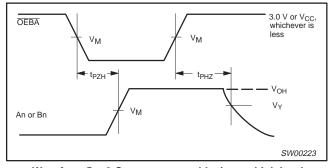
Waveform 2. Propagation delay, transparent mode



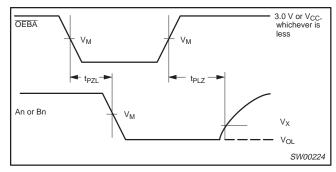
Waveform 3. Propagation delay, enable to output, and enable pulse width



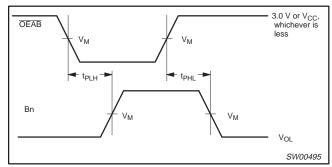
Waveform 4. Data setup and hold times



Waveform 5. 3-State output enable time to high level and output disable time from high level



Waveform 6. 3-State output enable time to low level and output disable time from low level

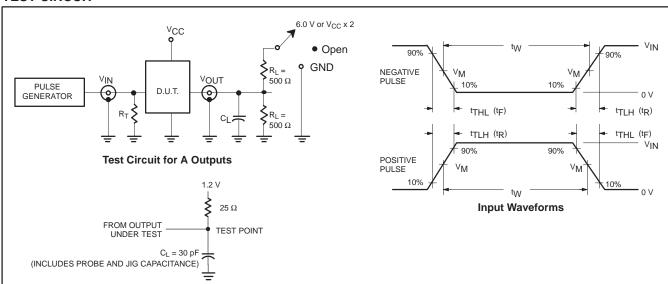


Waveform 7. Output enable time on open collector output with pull-up

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

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TEST CIRCUIT



Load Circuit for B Outputs

SWITCH POSITION

| TEST | SWITCH |
|------------------------------------|--------|
| t _{PLZ} /t _{PZL} | 6 V |
| t _{PLH} /t _{PHL} | Open |
| t _{PHZ} /t _{PZH} | GND |

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$ capacitance includes jig and probe capacitance: See AC CHARACTERISTICS for value.

 $R_T = -$ Termination resistance should be equal to Z_{OUT} of pulse generators.

| | INPUT PULSE REQUIREMENTS | | | | | | | | |
|--------|--|-----------|----------------|----------------|----------------|--|--|--|--|
| FAMILY | Amplitude | Rep. Rate | t _W | t _R | t _F | | | | |
| GTLP | 3.0 V or V _{CC} whichever is less | ≤10 MHz | 500 ns | ≤2.5 ns | ≤2.5 ns | | | | |

SW00255

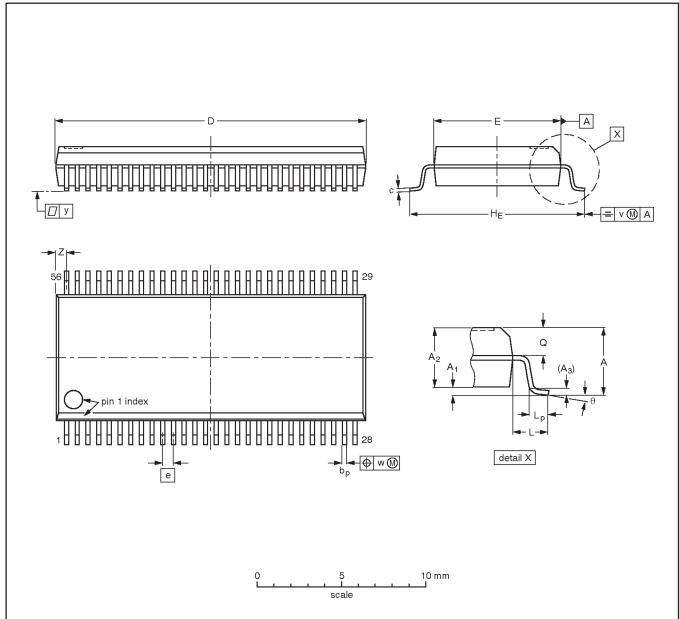
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SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-------|--------------|-----|------------|------------|------|------|-----|------------------|----------|
| mm | 2.8 | 0.4 0.2 | 2.35 2.20 | 0.25 | 0.3 0.2 | 0.22 0.13 | 18.55 18.30 | 7.6 7.4 | 0.635 | 10.4 10.1 | 1.4 | 1.0 0.6 | 1.2 1.0 | 0.25 | 0.18 | 0.1 | 0.85 0.40 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

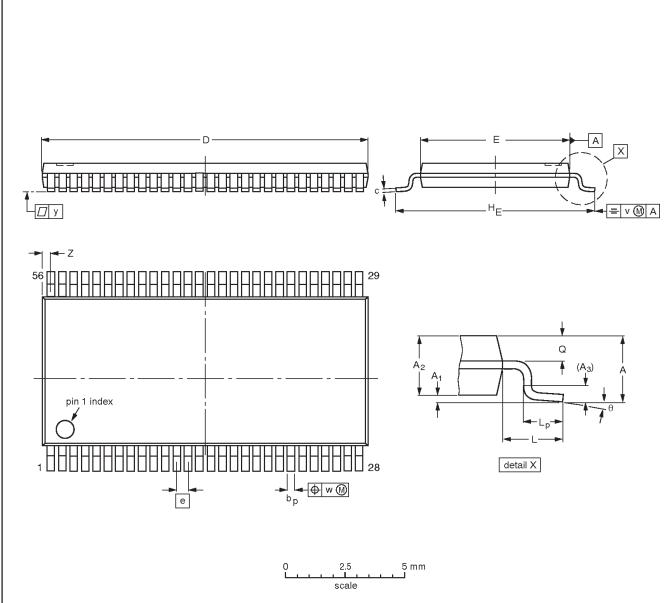
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE |
| SOT371-1 | | MO-118 | | | | 95-02-04 99-12-27 |

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

GTLPH16612

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

| UNIT | A max. | Α1 | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽²⁾ | е | HE | L | Lp | Q | v | w | у | Z | θ |
|------|-----------|--------------|----------------|----------------|--------------|------------|------------------|------------------|-----|------------|-----|------------|--------------|------|------|-----|------------|----------|
| mm | 1.2 | 0.15 0.05 | 1.05 0.85 | 0.25 | 0.28 0.17 | 0.2 0.1 | 14.1 13.9 | 6.2 6.0 | 0.5 | 8.3 7.9 | 1.0 | 0.8 0.4 | 0.50 0.35 | 0.25 | 0.08 | 0.1 | 0.5 0.1 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|-----|--------|----------|------------|------------|-----------------------------------|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE |
| SOT364-1 | | MO-153 | | | | -95-02-10- 99-12-27 |

2001 Sep 28 12

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

GTLPH16612

NOTES

2001 Sep 28 13

18-bit GTLP to LVTTL/TTL bidirectional universal translator (3-State)

GTLPH16612

Data sheet status

| Data sheet status ^[1] | Product status ^[2] | Definitions |
|----------------------------------|----------------------------------|--|
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^[1] Please consult the most recently issued data sheet before initiating or completing a design.

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